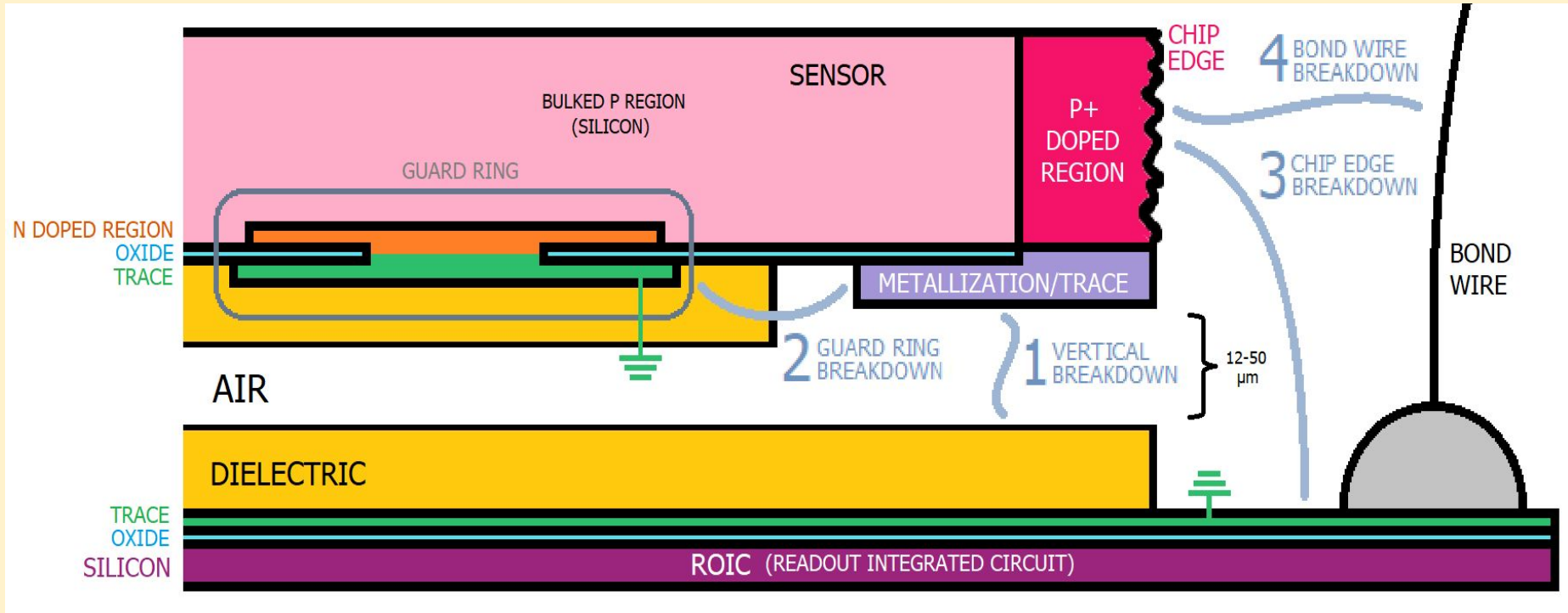


Development of Suitable Dielectrics for the High Luminosity LHC: Phase 2

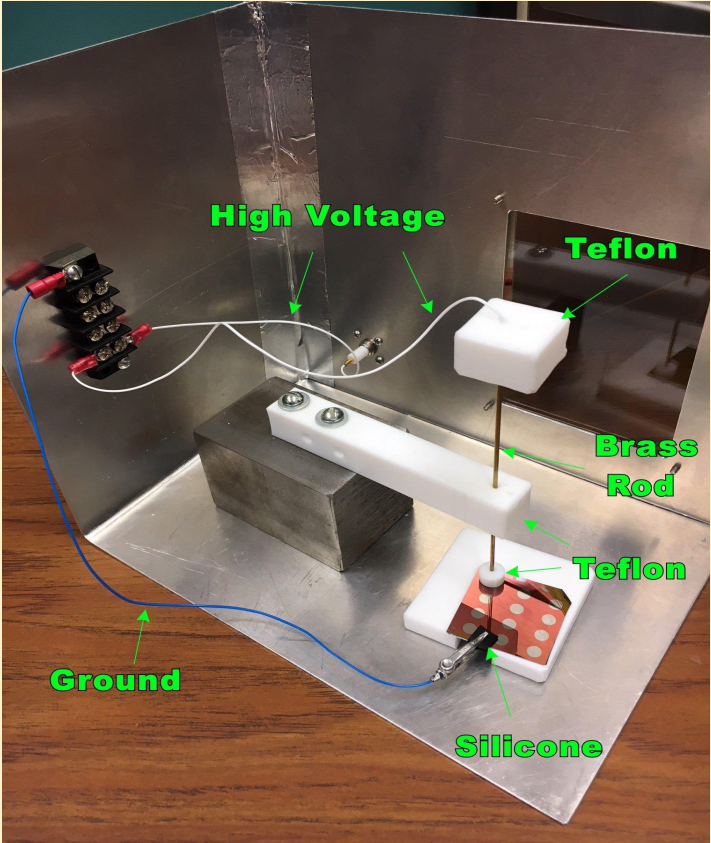
Selene Cheung, University of California, Davis
NorCal HEP-EX, December 1, 2018



Phase 2: Testing Vertical Breakdown (1)



Previous Testing Apparatus for Breakdowns w/o Air Gap



Current Testing Apparatus for Breakdowns with Air Gap

Kapton Tape on the box (for insulation)

Ground (Box)

High Voltage Wire

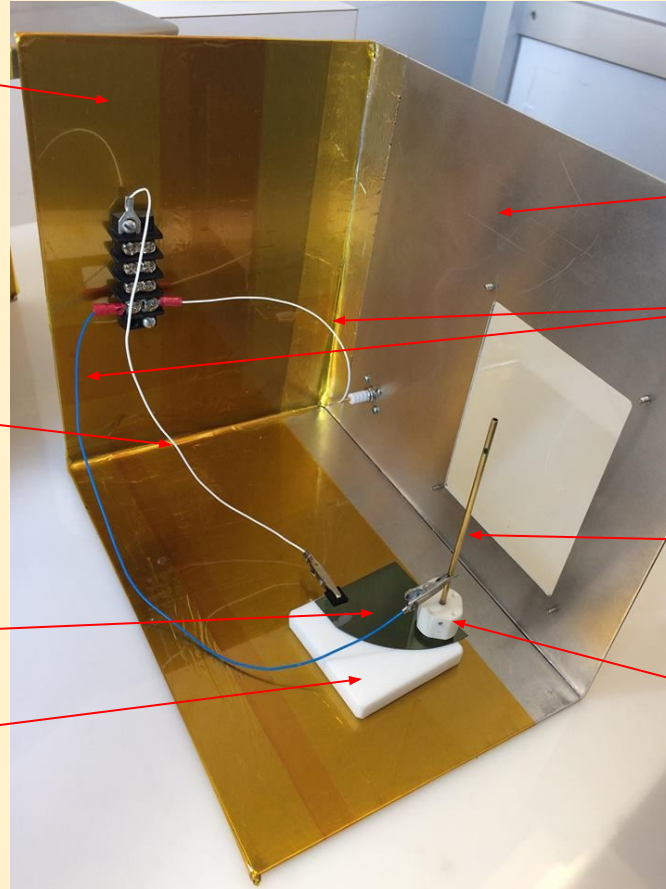
Grounding Wire

Air Gap Probe's
Brass Rod

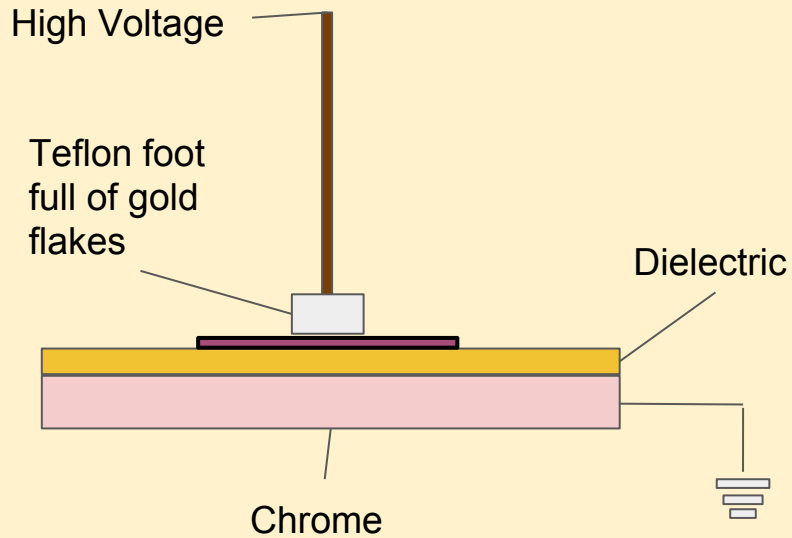
Dielectric Chip

Air Gap Probe's
Ceramic Foot

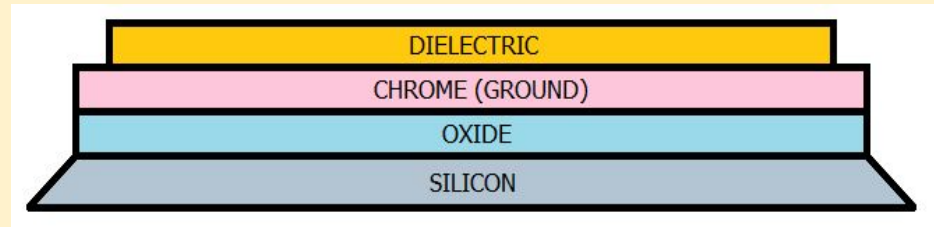
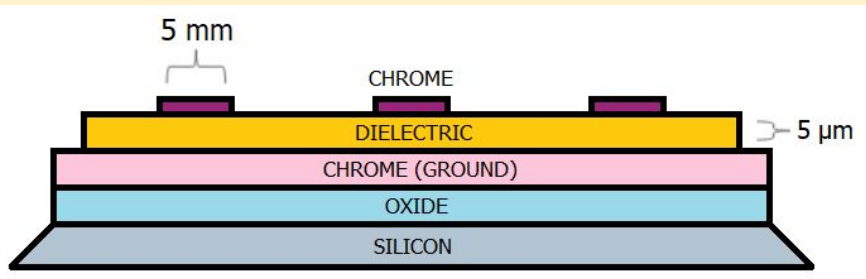
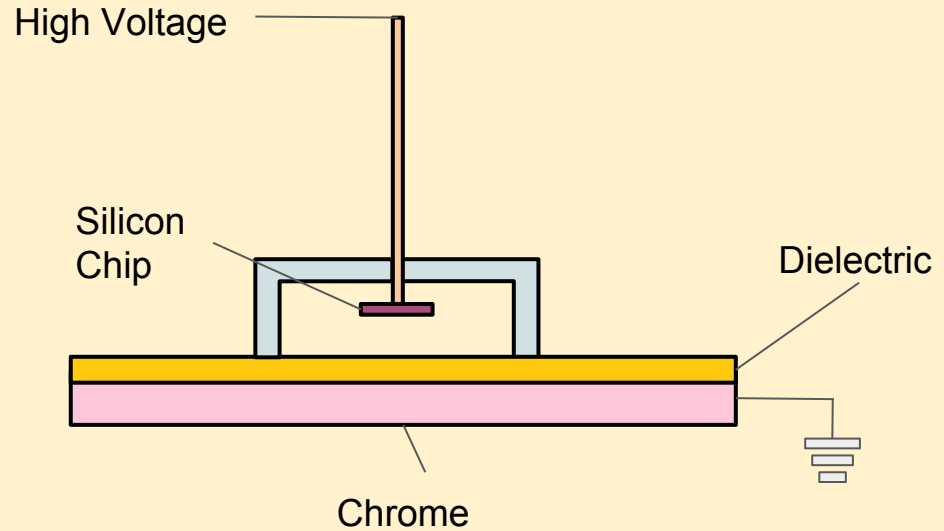
Teflon Pedestal



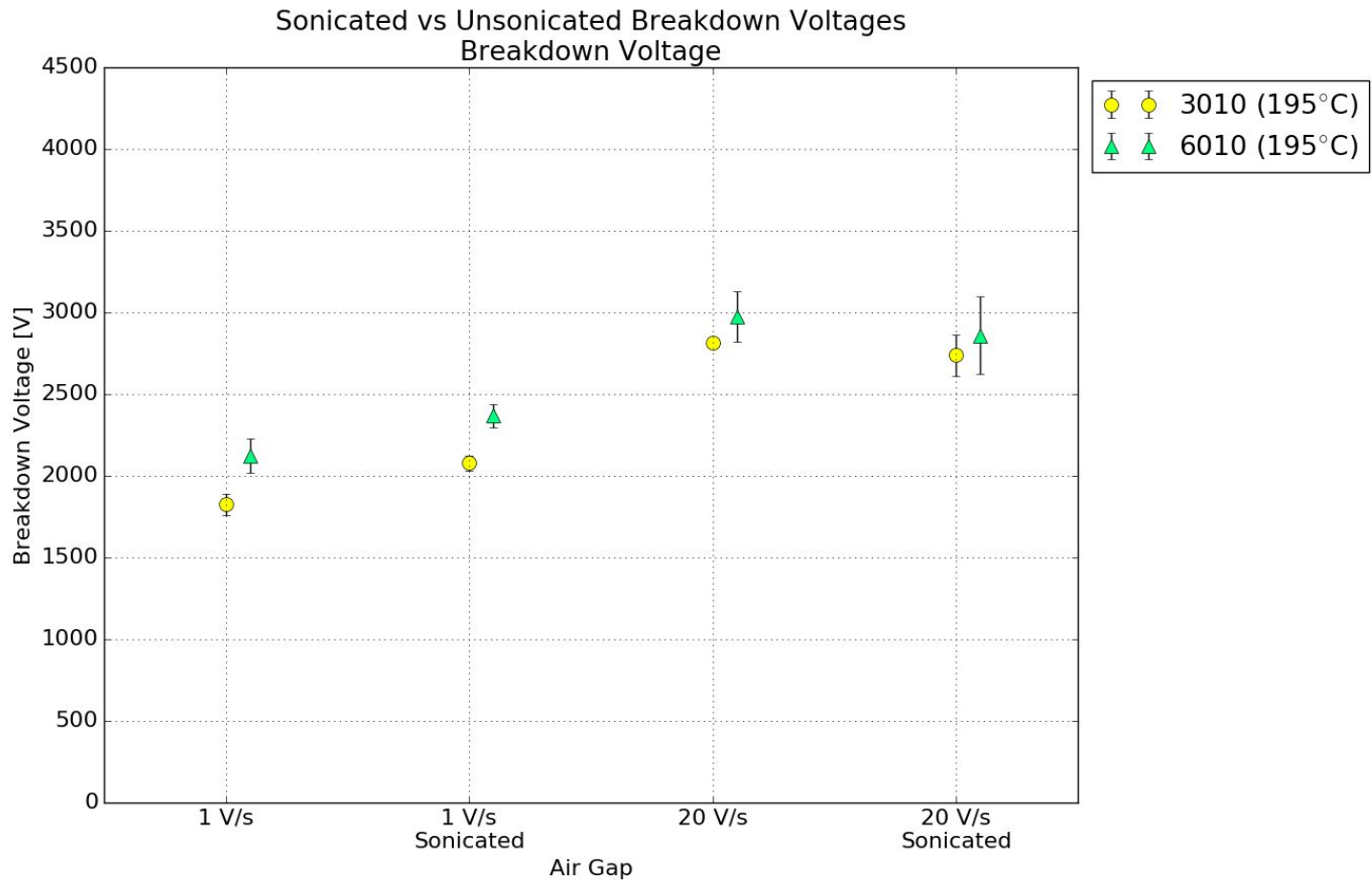
Gold Probe



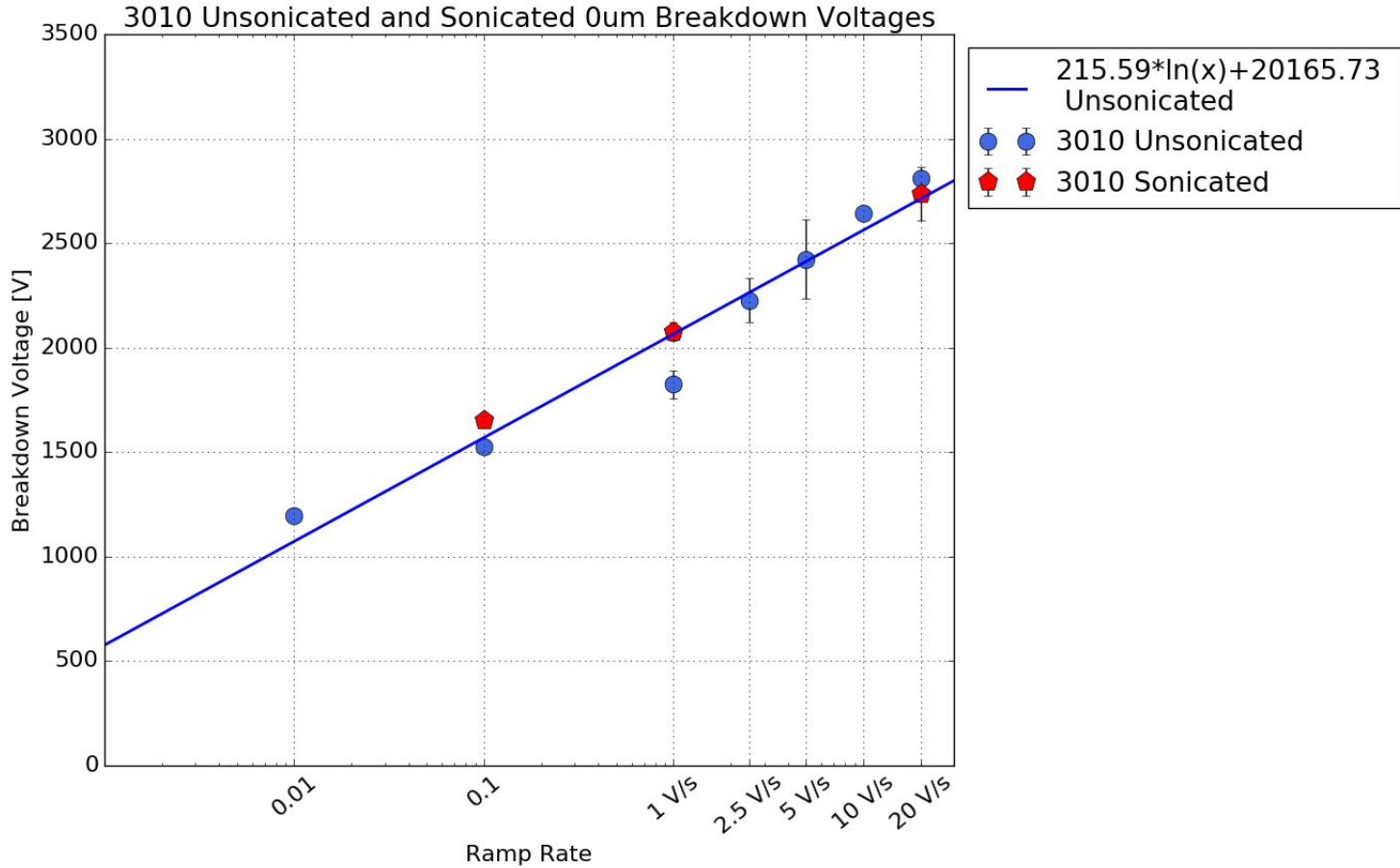
Air Gap Probe



Effect of Sonication on Breakdown

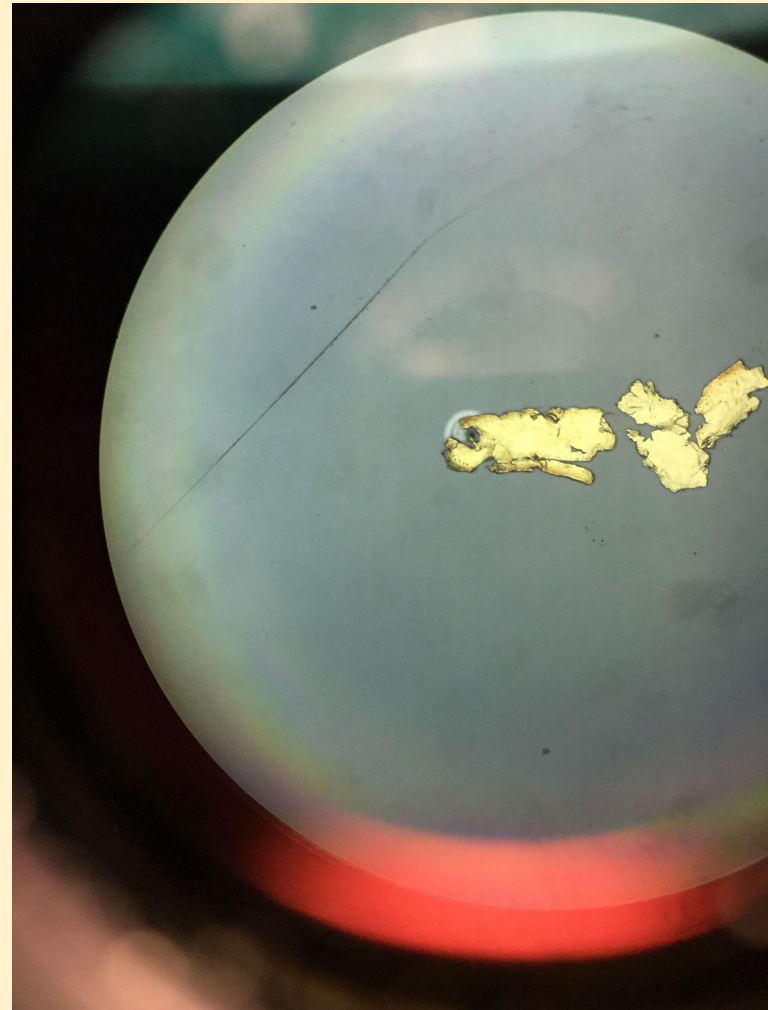


Effects of Ramp Rate on Breakdown



Effects of Heating on Breakdown

- Current leakage and time-dependent breakdown are not properties of our setup, but the material.
- Potential cause: localized heating, resistance to current flow increases the temperature which increases the current flow which increases the temperature... etc.



Effects of Photoresist Defects on Breakdown

